

Corrected Application Data Sheet .



Inventor Information

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Application Information

Title Line One:: HEAT-RESISTANT COMPOSITION
Total Drawing Sheets:: 0
Formal Drawings:: No
Docket Number:: 215697
Application Type:: Utility
Secrecy Order in Parent Appl.?: No

Representative Information

Representative Customer Number :: 23460

Prior Foreign Applications

Foreign Application:: 2001-34161
Filing Date:: February 9, 2001
Country:: Japan
Priority Claimed:: Yes

Assignee Information

Name of Assignee One: Toyo Boseki Kabushiki Kaisha
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